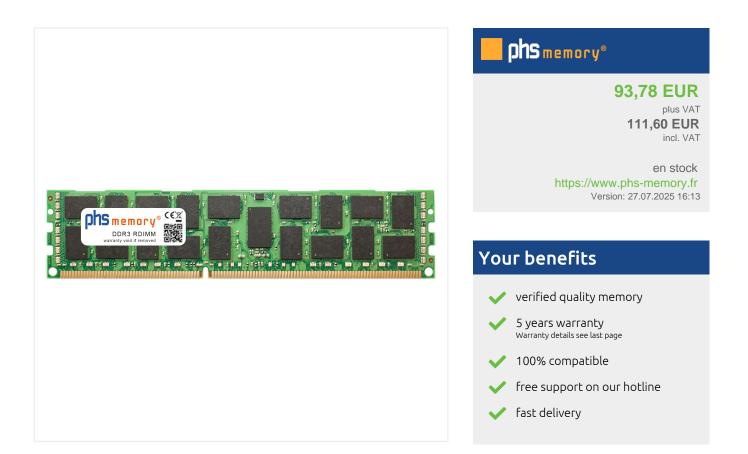


## 32GB Computer memory DDR3 for ORACLE SUN Fire X4170 RDIMM



## PHS-memory® - computer memory with 100% quality

- many years of IT competence
- Free support for optimal configuration and product selection
- High availability through professional warehouse management
- Fast delivery in throughout Europe
- Short response times and professional order processing due to full digitalization throughout the entire process with complete traceability
- Incoming goods inspection include checks of the DRAMs, PCBs and the programmed SPDs in order to exclude possible errors (Controlled BOM).
- PHS-memory® brand memories guarantee 100% compatibility to the specified system.
- PHS-memory® memories can be used together with existing memories in the device depends on to the configuration rules of the system.
- The "fallback option" in the SPD of PHS-memory® allows DRAMs with higher clock rates to be operated together with older memory modules with lower clock rates within the system.
- Products with unique serial number for service and warranty
- Pre-sales and after-sales support by technically trained personnel



## Memory Specification



Memory size	32GB		
Memory technology	DDR3		
ECC support	yes		
JEDEC Norm	PC3-10600R		
DRAM Organization	2Gx4		
Rank	4Rx4 (4DRx4 DDP)		
Туре	RDIMM (ECC Registered)		
Number of pins	240 Pin DIMM		
Memory data transfer rate	1333MHz @ CL9		
Speciality	DDP		
Board dimensions	133,35 x 30 (LxB mm)		
Operating temperature	0° C - 85° C		
Storage temperature	-40° C - +95° C		
RoHS compliant	yes		
SKU	SP466082		
EAN	4067488295829		

#### overRAMing maximize your RAM



Most systems - including the ORACLE SUN Fire X4170 - can be upgraded with more memory than originally specified by the device manufacturer.

Therefore, our memory specialists continuously analyze new memory solutions in selected systems. Due to improved manufacturing technologies, new memories with higher performance and capacity will be tested for stability and functionality. Then the new memory solutions are released for the respective systems

released for the respective systems. Use the benefits of larger computer memory capacity with the PHSmemory® overRAMing memory solutions.

https://www.phs-memory.fr/-BOR

Note: The module specified in this datasheet is one of several possible configurations available under this part number.

Some details may differ from the specifications described here and the illustration, but have no negative influence on the functionality.



## System Specifications

The memory is 100% compatible with this sytem:

System manufacturer	ORACLE		
Device type	Server		
Device family	SUN Server		
Device series	Fire X Serie		
Device name	SUN Fire X4170		
Maximum memory*	576GB / 144GB according to manufacturer		
Number of memory sockets	18		

\* The specifications for the maximum memory upgrade may differ from those of the manufacturer ORACLE. Often the information given in the manual for the maximum memory upgrade is not up to date. New memory technologies, bios updates or newer software versions often allow the use of memory modules with a higher capacity than specified by the manufacturer with the same performance and stability.

Memory modules with our overRAMing-symbol are approved by us for maximum memory expansion.

## Information on memory allocation

#### Computer memory configuration:

Our memory team will be happy to help you choose the right memory and configure your server.

Principles of memory assembly

- Die memorysteckplätze sind in 3er Gruppen organisiert
- Die verschiedenen 3er Steckplatzgruppen müssen nicht die gleichen Kapazitäten haben
- Es können nur die memorysteckplätze genutzt werden, bei denen die jeweilige CPU vorhanden ist.

Memory configuration for good system performance

- Bei jeweils 3 gleichen memoryn pro 3er Steckplatzgruppe, ist die Performance until zum 3fachen schneller gegenüber einer Bestückung der 3er Steckplatzgruppe with nur einem memory
- Wenn mehr als eine CPU vorhanden sind, sollten die memory pro CPU identisch (gespiegelt zur anderen CPU) bestückt werden.

## Information on memory installation

- Turn off the system
- Remove the plug of the power supply unit (if connected)
- Remove the battery, according to the user manual of the system
- Always ground yourself before touching electronic components
- Protect the memory module from static voltages:
- Do not touch the gold pins of the memory module
- Only touch the sides of the memory module
- Use a grounding strap and/or ESD glove if possible



General installation instructions are supplied by E-Mail.

# phs memory®

## Further memory options for ORACLE SUN Fire X4170

Size	SKU	Technology	Туре	Number of pins	Brand	Reference no.
8GB	SP236701	DDR3	RDIMM (ECC Registered)	240 Pin DIMM	PHS-memory®	
16GB	SP466083	DDR3	RDIMM (ECC Registered)	240 Pin DIMM	PHS-memory®	
32GB	SP466082	DDR3	RDIMM (ECC Registered)	240 Pin DIMM	PHS-memory®	

## PHS-memory® warranty

Every PHS-memory® is equipped with a 5-years-warranty of perfect operation. If the RAM module is defective or fails within 5 years of purchase when used properly, you will receive an appropriate RAM module free of charge. If a suitable memory module is no longer available, we will refund the purchase price.

For more information on warranty and service please visit https://www.phs-memory.fr/-W5Y



## Contact Information

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All information without guarantee. Technical changes and errors excepted. You can find current price information in our online shop at https://www.phs-memory.fr